OCKET NO.: UPNA-0034/P2925

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Arjun G. Yodh, et al.

Confirmation No.: 7568

Application No.: 10/526,941

Group Art Unit: 1751

Filing Date: September 8, 2005

Examiner: Not Yet Assigned

CARBON NANOTUBES: HIGH SOLIDS DISPERSIONS AND NEMATIC

GELS THEREOF

DATE OF DEPOSIT: DECEMBER 8, 2006

I HEREBY CERTIFY THAT THIS PAPER IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL, POSTAGE PREPAID, THE DATE INDICATED ABOVE AND ADDRESSED TO THE UNITED STATES PATENT AND TRADEMARK OFFICE, P.O. BOX 1450, ALEXANDRIA,

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Dear Sir:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Pursuant to 37 CFR § 1.56 and in accordance with 37 CFR §§ 1.97-1.98, information relating to the above-identified application is hereby disclosed. Inclusion of information in this statement is not to be construed as an admission that this information is material as that term is defined in 37 CFR § 1.56(b).

In accordance with § 1.97(b), since this Information Disclosure Statement is 冈 being filed either within three months of the filing date of the above-identified application, within three months of the date of entry into the national stage of

	the above identified application as set forth in § 1.491, before the mailing date
	of a first Office Action on the merits of the above-identified application, or
	before the mailing date of a first Office Action after the filing of request for
	continued examination under § 1.114, no additional fee is required.
	In accordance with § 1.97(c), this Information Disclosure Statement is being
	filed after the period set forth in § 1.97(b) above but before the mailing date of
	either a Final Action under § 1.116 or a Notice of Allowance under § 1.311, or
	before an action that otherwise closes prosecution in the application, therefore:
	Certification in Accordance with § 1.97(e) is attached; or
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	of the Issue Fee, therefore included are: Certification in Accordance with §
	1.97(e); and the submission fee of <u>\$180.00</u> as set forth in § 1.17(p).
\boxtimes	Copies of reference numbers 168 - 204 listed on the attached Form PTO-1449
	are enclosed herewith.
\boxtimes	Copies of reference numbers 149 - 167 on the attached Form PTO 1449 are
	not required to be submitted pursuant to 37 CFR § 1.98(a)(2)(i).
	Copies of references - are not being submitted because
	they were previously cited by or submitted to the U.S. Patent and
	Trademark Office in patent application number , filed for
	which a claim for priority under 35 U.S.C. § 120 has been made in the
	instant application.

DOC	KET NO.: UPNA-0034/P2952	-3-	PATENT
	The relevance of those listed refere follows:	ences which are not in the English la	inguage is as
	There are no listed references which	are not in the English language.	
	Please charge any deficiency or cre	edit any overpayment to Deposit Acc	ount No. 23-
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Date:	December 7, 2006	Jeffrey H. Rosedale Registration No. 46,018	rdale_

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Form PTO-1449 Modified

List of Patent and Publications Cited by Applicant (Use several sheets if necessary)

U.S. Department of Commerce Patent and Trademark Office

Docket No.	A
UPNA-0034/P2	

Application No. 10/526,941

Applicant

Arjun G. Yodh, et al.

Filing Date September 8, 2005 Group 1751

Confirmation No. 7568

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